

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	2.2kΩ
R ₂	47kΩ

Features

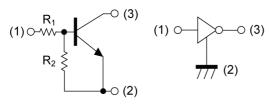
- 1) Built-In Biasing Resistors
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA123J sereis

Application

INVERTER, INTERFACE, DRIVER

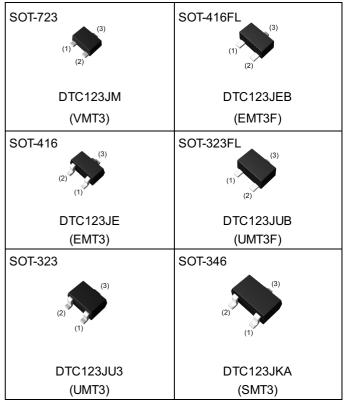
•Inner circuit

DTC123JM/ DTC123JEB/ DTC123JUB

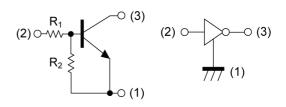


- (1) IN (BASE)
- (2) GND (EMITTER)
- (3) OUT (COLLECTOR)

Outline



DTC123JE/ DTC123JU3/ DTC123JKA



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC123JM	SOT-723	1212	T2L	180	8	3000	E42
DTC123JEB	SOT-416FL	1616	TL	180	8	3000	E42
DTC123JE	SOT-416	1616	TL	180	8	3000	E42
DTC123JUB	SOT-323FL	2021	TL	180	8	3000	142
DTC123JU3	SOT-323	2021	T106	180	8	3000	142
DTC123JKA	SOT-346	2928	T146	180	8	3000	E42

● **Absolute maximum ratings** (T_a = 25°C)

Pa	arameter	Symbol	Values	Unit
Supply voltage	V _{CC}	50	V	
Input voltage		V _{IN}	-5 to 12	V
Output current		Io	100	mA
Collector current			100	mA
	DTC123JM		150	mW
	DTC123JEB		150	
Davis and distribution	DTC123JE	D *2	150	
Power dissipation	DTC123JUB	P _D *2	200	
	DTC123JU3		200	
	DTC123JKA		200	
Junction temperature	T _j	150	°C	
Range of storage temperat	ure	T _{stg}	-55 to +150	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offit
Innut voltore	$V_{I(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	V
Input voltage	V _{I(on)}	$V_{O} = 0.3V, I_{O} = 5mA$	1.1	-	-	V
Output voltage	V _{O(on)}	I _O = 5mA, I _I = 0.25mA	1	100	300	mV
Input current	I _I	V _I = 5V	1	-	3.6	mA
Output current	I _{O(off)}	$V_{CC} = 50V, V_{I} = 0V$	1	-	500	nA
DC current gain	G _I	V _O = 5V, I _O = 10mA	80	-	-	-
Input resistance	R ₁	-	1.54	2.2	2.86	kΩ
Resistance ratio	R ₂ /R ₁	-	17	21	26	-
Transition frequency	f _T *1	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor.

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

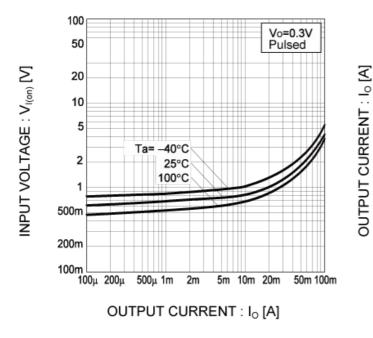


Fig.2 Output current vs. input voltage (OFF characteristics)

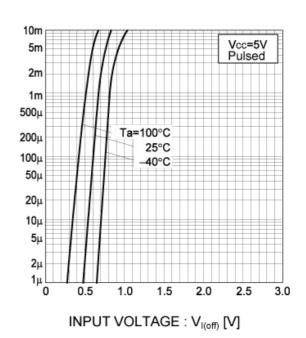


Fig.3 Output current vs. output voltage

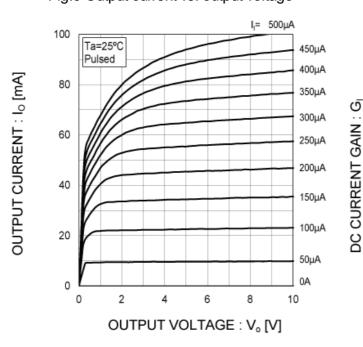
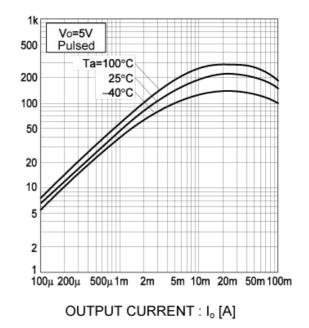
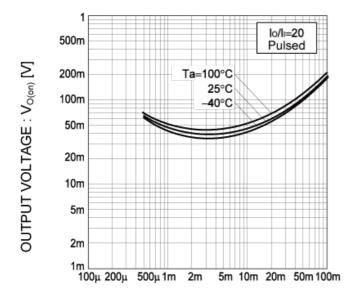


Fig.4 DC current gain vs. output current

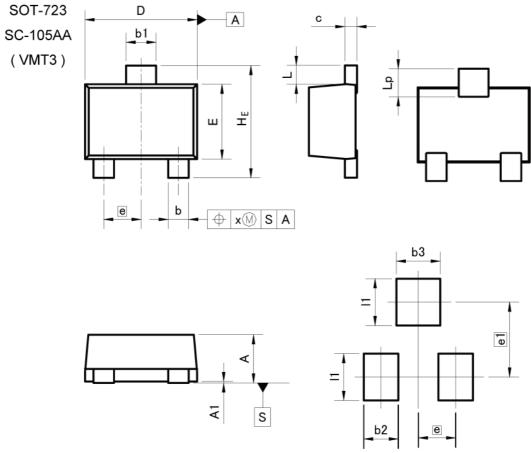


●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT: Io [A]



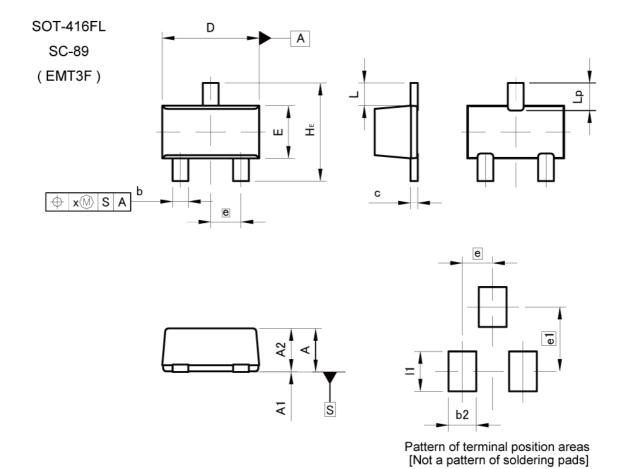
Pattern of terminal position	areas
[Not a pattern of soldering	pads]

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.	40	0 0.	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	_	0.10	_	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50		0.020

Dimension in mm/inches



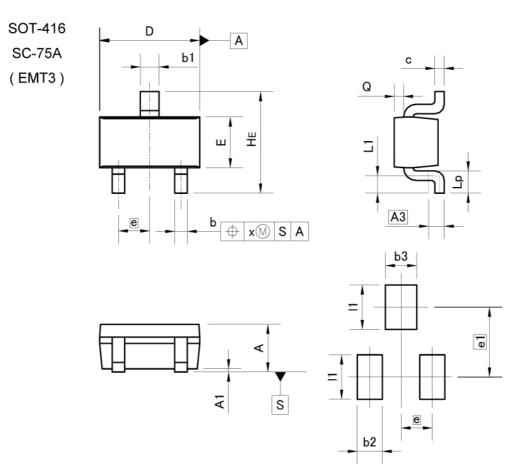


DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
×	-	0.10	_	0.004

MILIMETERS INCHES DIM MIN MAX MIN MAXb2 0.46 0.018 1.05 0.041 e1 0.65 0.026 11

Dimension in mm/inches





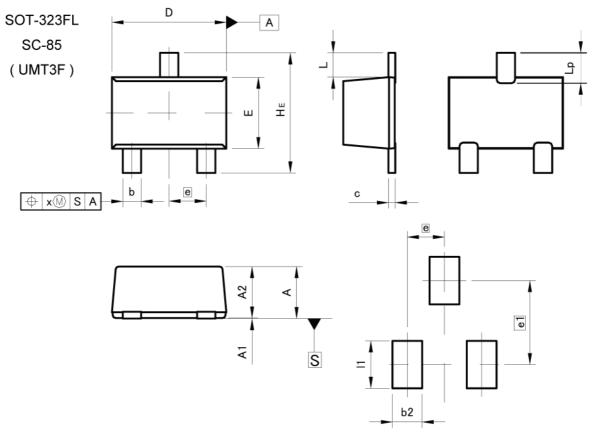
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lр	0.15		0.006	% -
Q	0.05	0.25	0.002	0.010
х	1.7	0.10	Ę	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	143
l1	i -	0.70	-	0.028

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.	43	0.0	17
Lp	0.43	0.63	0.017	0.025
х	-	0.10	-	0.004

DIM	MILIM	MILIMETERS		HES
DIW	MIN	MAX	MIN	MAX
b2	-	0.52	ı	0.020
e1	1.47		0.0	58
l1	-	0.83	=	0.033

Dimension in mm/inches





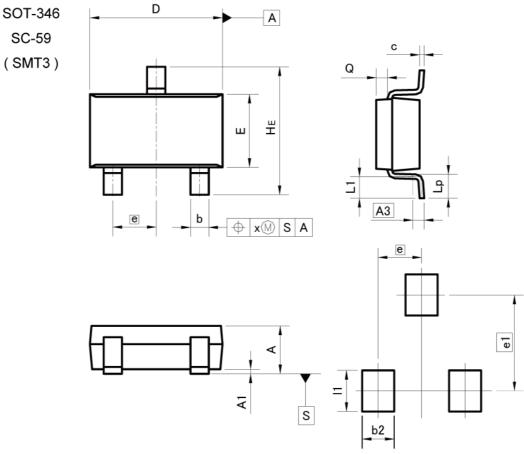
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0	0.004
A3	0.25		0.01	
b	0.25	0.40	0.01	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.03	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	-	0.50	1	0.02
11	_	0.65	_	0.026

Dimension in mm/inches





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	e=	0.004
у	- 2	0.10	(-	0.004

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
	b2		0.60	_	0.024
	e1	2.10		0.083	
	11	-3	0.90	-	0.035

Dimension in mm/inches



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Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.003

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Rev.001

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SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F) RN4605(TE85L,F) TTEPROTOTYPE79

DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G NSVMUN5113DW1T3G

SMUN5230DW1T1G SMUN5133T1G SMUN2214T1G DTC114EUA-TP NSBA144EF3T5G NSVDTA114EET1G 2SC2223-T1B-A

2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G NSVMUN5135DW1T1G

NSVMUN2237T1G NSVDTC143ZM3T5G SMUN5335DW1T2G SMUN5216DW1T1G